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Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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HAT2160H

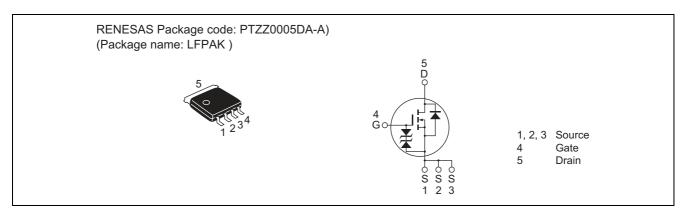
Silicon N Channel Power MOS FET Power Switching

REJ03G0002-0300 Rev.3.00 Sep 26, 2005

Features

- Capable of 4.5 V gate drive
- Low drive current
- High density mounting
- Low on-resistance $R_{DS(on)} = 2.1 \text{ m}\Omega \text{ typ. (at } V_{GS} = 10 \text{ V)}$

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	20	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	60	A
Drain peak current	I _{D(pulse)} Note1	240	Α
Body-drain diode reverse drain current	I _{DR}	60	Α
Avalanche current	I _{AP} Note 3	30	Α
Avalanche energy	E _{AR} Note 3	90	mJ
Channel dissipation	Pch Note2	30	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. $PW \le 10 \infty$, duty cycle $\le 1\%$

2. Tc = 25°C

3. Value at Tch = 25°C, Rg \geq 50 Ω

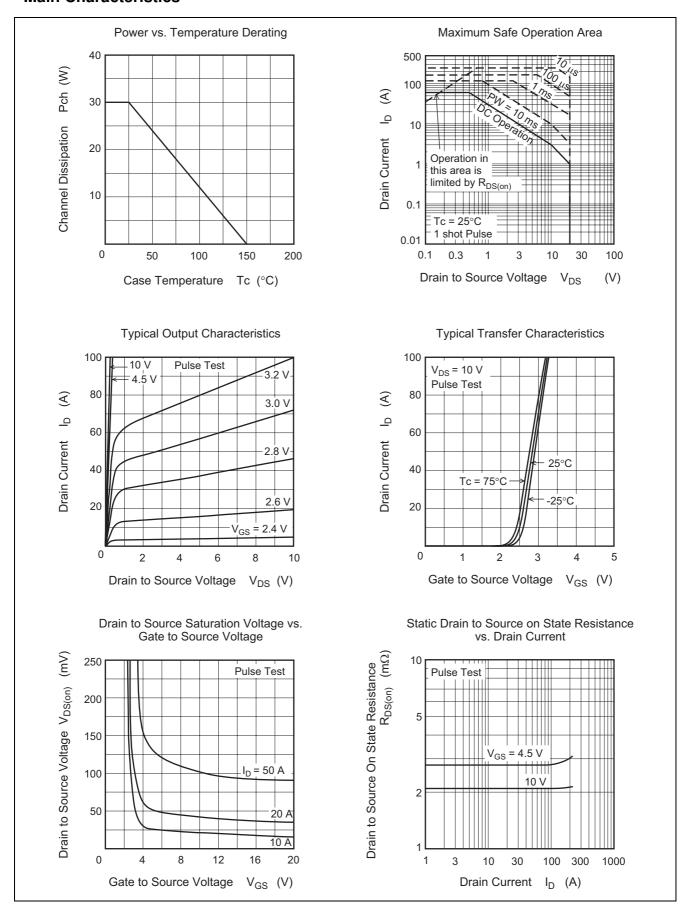
Electrical Characteristics

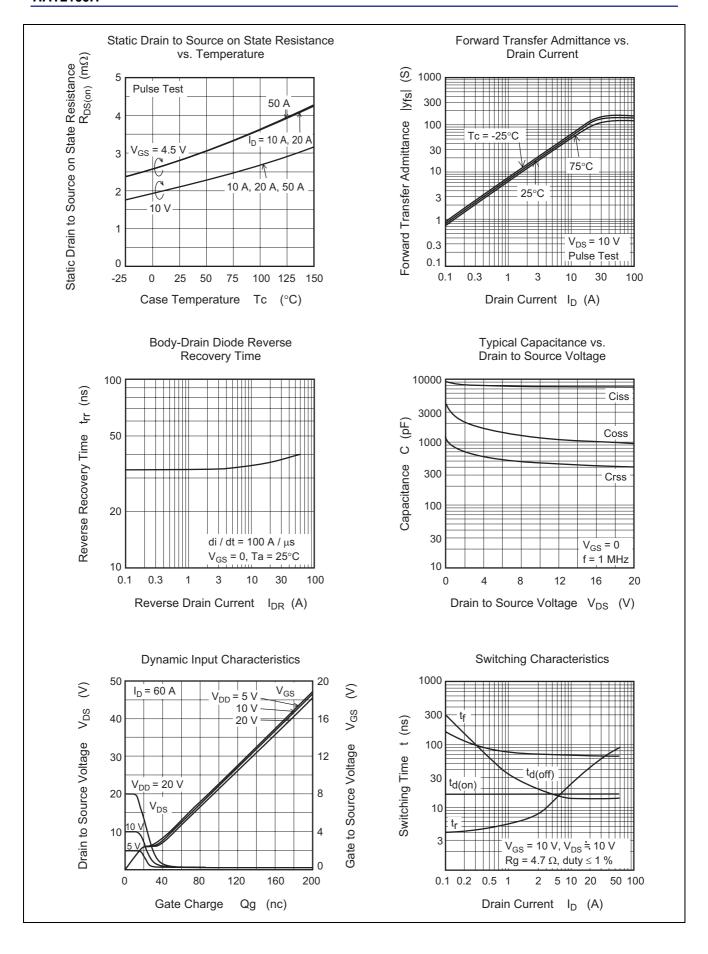
 $(Ta = 25^{\circ}C)$

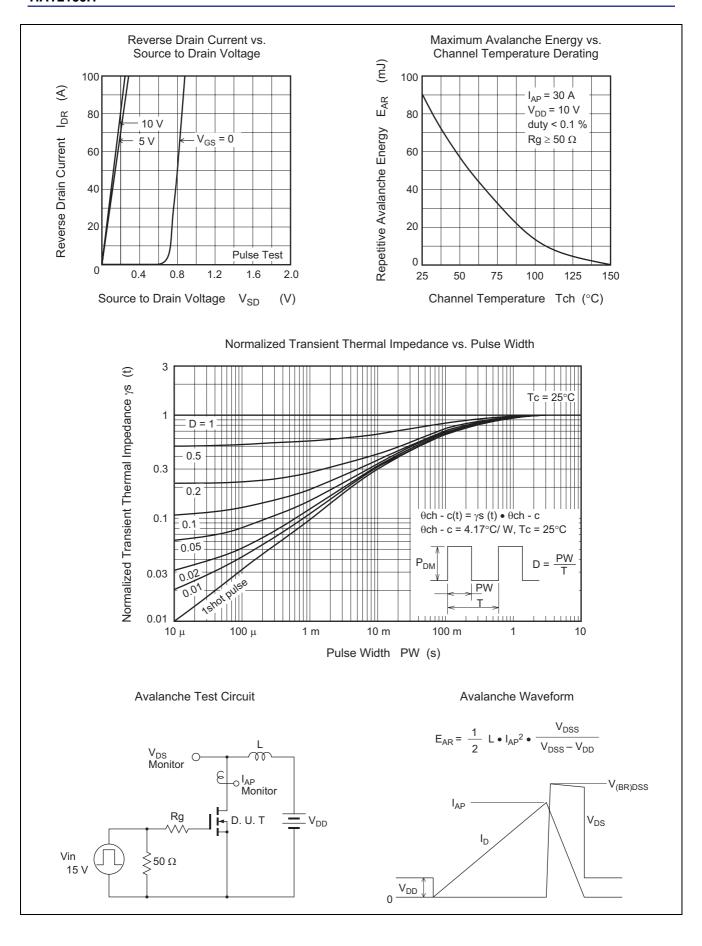
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	20			٧	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20			٧	$I_G=\pm 100 \propto\!\!A,\ V_{DS}=0$
Gate to source leak current	I _{GSS}			±10	∝A	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}			1	∝A	$V_{DS} = 20 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	8.0		2.3	>	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$
Static drain to source on state	R _{DS(on)}		2.1	2.6	mΩ	$I_D = 30 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$
resistance	R _{DS(on)}		2.8	4.1	mΩ	$I_D = 30 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note4}}$
Forward transfer admittance	y _{fs}	78	130		S	$I_D = 30 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$
Input capacitance	Ciss		7750		pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$
Output capacitance	Coss	_	1220		рF	
Reverse transfer capacitance	Crss	_	450	_	рF	
Gate resistance	Rg		0.5	_	Ω	
Total gate charge	Qg		54	_	nC	$V_{DD} = 10 \text{ V}, V_{GS} = 4.5 \text{ V},$
Gate to source charge	Qgs		19	_	nC	$I_D = 60 \text{ A}$
Gate to drain charge	Qgd		14	_	nC	
Turn-on delay time	t _{d(on)}		17	_	ns	$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A},$
Rise time	t _r		60	_	ns	$V_{DD}\cong 10~V,~R_L=0.33~\Omega,$
Turn-off delay time	$t_{d(off)}$		65	_	ns	$Rg = 4.7 \Omega$
Fall time	t _f		15	_	ns	
Body-drain diode forward voltage	V_{DF}	_	0.82	1.07	V	$IF = 60 A$, $V_{GS} = 0$ Note4
Body-drain diode reverse recovery	t _{rr}	_	40	_	ns	IF = 60 A, V _{GS} = 0
time						$di_F/dt = 100 \text{ A/} \sim s$

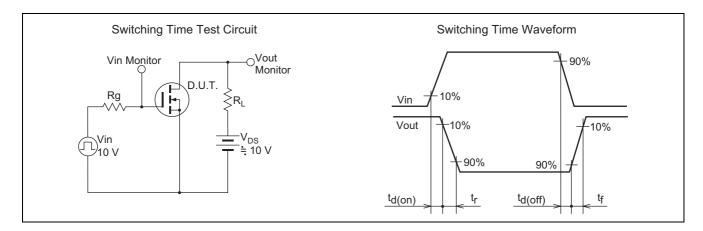
Notes: 4. Pulse test

Main Characteristics

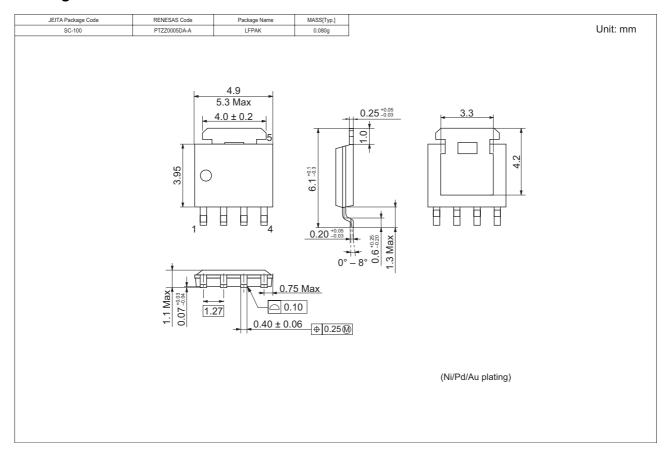








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
HAT2160H-EL-E	2500 pcs	Taping

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